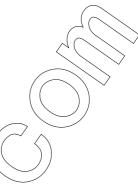
GaAs Infrared LED

# SANYO Ultraminiature photointerrupter (single-transistor type)

#### Features

- GaAs Infrared LED plus Single Phototransistor
- Photo-Interrupter
- Contact type
- Compact type : H3.25 × L5.0 × W4.5mm
- Application : For the general public welfare



#### Absolute Maximum Ratings at Ta=25°C, 65%RH (as per JIS C 7032)

Parameter	Symbol _	<b>Rating</b>	Unit
Forward Current *1		50	mA
Reverse Voltage	VR V	5	V
Power Dissipation	PD	70	mW
Collector-Emitter Voltage	VCE0	20	V
Emitter-Collector Voltage	$\langle V_{ECO} \rangle$	5	V
Collector Curren		20	mA
Power Dissipation	P <sub>C</sub>	70	mW
Operating Temperature		-20 to +80	°C
Storage Temperature		-30 to +85	°C
Soldering Temperature *2		260	°C
	Forward Current *1 Reverse Voltage Power Dissipation Collector-Emitter Voltage Emitter-Collector Voltage Collector Curren Power Dissipation erating Temperature torage Temperature	Forward Current *1IFReverse VoltageVRPower DissipationPDCollector-Emitter VoltageVCEOEmitter-Collector VoltageVECOCollector CurrenIcPower DissipationPCerating TemperatureToprcorage TemperatureTstg	Forward Current *1IF50Reverse VoltageVR5Power DissipationPb70Collector-Emitter VoltageVCEO20Emitter-Collector VoltageVECO5Collector CurrenIC20Power DissipationPc70erating TemperatureTopr-20 to +80corage TemperatureTstg-30 to +85

\*1 See forward current derating

\*2 Soldering conditions : time : max. 3sec; clearance : min. 1mm from lower stay



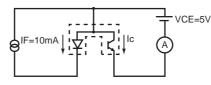
### Electro-Optical Characteristics at Ta=25°Ç, 65%RH

	Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Input	Forward Voltage	VF	I <sub>F</sub> =10mA	1.0	1.15	1.4	V
Input	Reverse Current	, I <sub>R</sub>	V <sub>R</sub> =5V	-	-	10	μΑ
Output	Dark Current	→ <sub>CEO</sub>	I <sub>F</sub> =0mA, V <sub>CE</sub> =10V	-	10	200	nA
	Collector Output Current	I <sub>C</sub>	I <sub>F</sub> =10mA,V <sub>CE</sub> =5V*1	240	500	880	μΑ
Coupled	Collector Emitter Saturation Voltage	V <sub>CE</sub> (sat)	I <sub>F</sub> =10mA, I <sub>C</sub> =50μA	-	-	0.5	V
	Rise Time	tr	$V_{CC}=5V, R_L=100\Omega$	-	5	-	μs
	Fall Time	tf	I <sub>C</sub> =1mA	-	5	-	μs

\*1 Measurement Circuit of Collector Current

* <sup>2</sup> Table of Classification of Co	ollector Output
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Class	Α	В	С
Ic (µA)	880 to 460	635 to 330	460 to 240

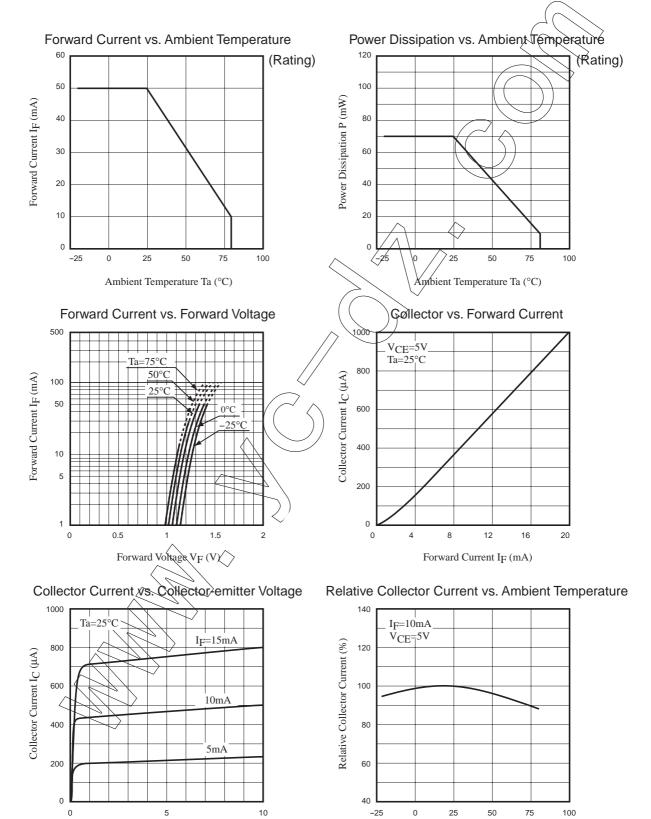


SANYO Electric Co., Ltd. Semiconductor Company TOKYO OFFICE Tokyo Bldg., 1-10, 1 Chome, Ueno, Taito-ku, TOKYO, 110-8534 JAPAN

#### **Typical Characteristics**

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These numerical value show the electrical and optical characteristics of this product, and not assure this contents.



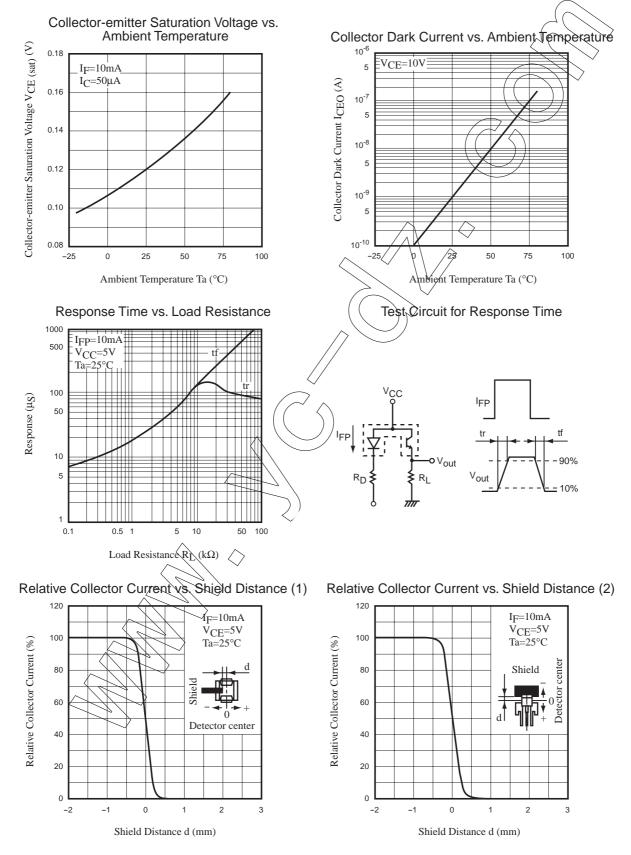
Collector-emitter Voltage  $V_{CE}(V)$ 

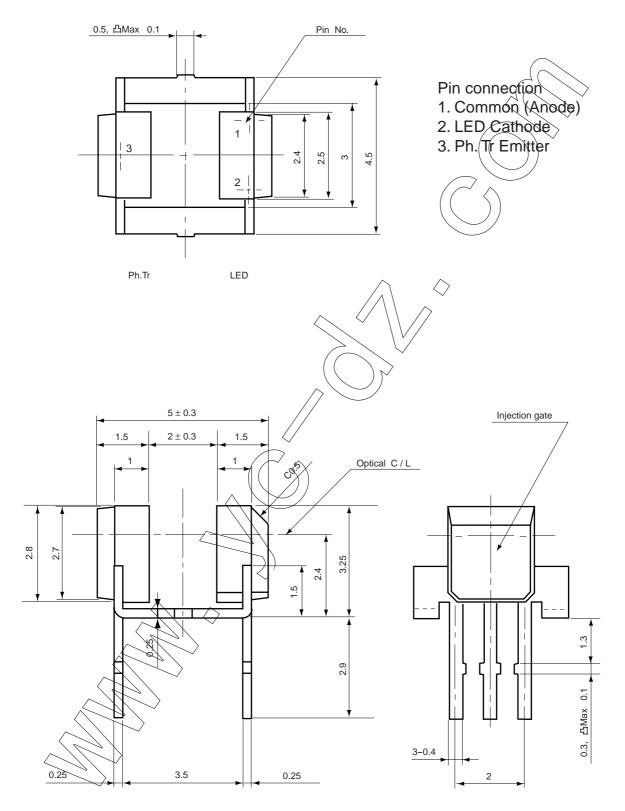
Ambient Temperature Ta (°C)

#### **Typical Characteristics**

#### 

These numerical value show the electrical and optical characteristics of this product, and not assure this contents.





Tolerance : ±0.2 Unit : mm

#### Package dimensions and Pin connection

As stated in the sttached paper. (No.6025 4/6)

#### **Soldering conditions**

- (1) Temperature : Max.  $260^{\circ}C$
- (2) Time : Max. 3 sec
- (3) Clearance : Min. 1mm from stay (include PCB thickness)

#### A PRECAUTIONS



- (1) Bending a lead should avoid. However, when bending is necessary, take care the next items.  $\langle$ 
  - $\bigcirc$  Bending a lead must be done before soldering.
  - 2 Bending a lead must be done in the states of fixing leads and no stress for the regin part. Because it is possible that stress for the regin part cause troubles such as gold wire breaking and so on.
  - ③ A lead must be bend under the stay.
  - (4) Do not bend the same position of leads more than twice.
- (2) The hole pitch of a circuit board must fit to the lead pitch.
- (3) Two stays coupling LED and Ph. Tr should be isolated from any PCB pattern or any lead.
- (4) Take core the following when soldering.
  - 1 Do not heat a product under any stress (a twist and so on) to leads.
  - 2 Do not heat a product in the states of operating force to the regin part.
- (5) Use the flux which contain no chlorine, have no corrosion and do not need washing.
- (6) Be careful that flux or other chemicals do not attach to the luminous surface and passive surface.



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## Precautionary instructions in handling gallium arsenic products

Special precautions must be taken in handling this product because it contains, gallium arsenic, which is designated as a toxic substance by law. Be sure to adhere strictly to all applicable laws and regulations enacted for this substance, particularly when it comes to disposal.

Manufactured by; Tottori SANYO Electric Co., Ltd. LED Division

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